DMA50101

Silicon PNP epitaxial planar type

For general amplification DMA20101 in SMini5 type package

■ Features

- High forward current transfer ratio h_{FE} with excellent linearity
- ullet Low collector-emitter saturation voltage $V_{\text{CE(sat)}}$
- Halogen-free / RoHS compliant
 (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

■ Marking Symbol: A0

■ Basic Part Number

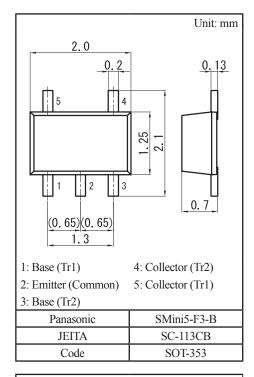
Dual DSA2001 (Common emitter)

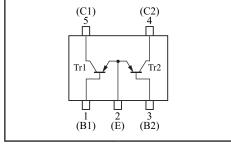
Packaging

DMA501010R Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	-60	V
Collector-emitter voltage (Base open)	V _{CEO}	-50	V
Emitter-base voltage (Collector open)	$V_{\rm EBO}$	-7	V
Collector current	I_{C}	-100	mA
Peak collector current	I _{CP}	-200	mA
Total power dissipation	P_{T}	150	mW
Junction temperature	T _j	150	°C
Operating ambient temperature	T _{opr}	-40 to +85	°C
Storage temperature	T _{stg}	-55 to +150	°C
	Collector-base voltage (Emitter open) Collector-emitter voltage (Base open) Emitter-base voltage (Collector open) Collector current Peak collector current Total power dissipation Junction temperature Operating ambient temperature	$\begin{array}{c} \text{Collector-base voltage (Emitter open)} & V_{\text{CBO}} \\ \text{Collector-emitter voltage (Base open)} & V_{\text{CEO}} \\ \text{Emitter-base voltage (Collector open)} & V_{\text{EBO}} \\ \text{Collector current} & I_{\text{C}} \\ \text{Peak collector current} & I_{\text{CP}} \\ \text{Total power dissipation} & P_{\text{T}} \\ \text{Junction temperature} & T_{\text{j}} \\ \text{Operating ambient temperature} & T_{\text{opr}} \\ \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$





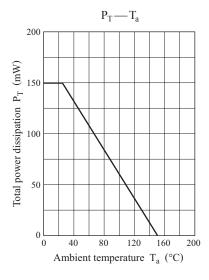
■ Electrical Characteristics $T_a = 25$ °C±3°C

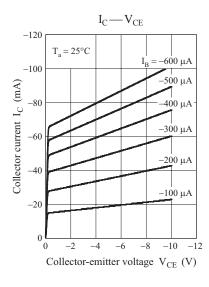
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = -10 \mu \text{A}, I_{\rm E} = 0$	-60			V
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = -2 \text{ mA}, I_B = 0$	-50			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = -10 \mu\text{A}, I_C = 0$	-7			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -20 \text{ V}, I_E = 0$			-0.1	μА
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = -10 \text{ V}, I_{B} = 0$			-100	μА
Forward current transfer ratio	h_{FE}	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$	210		460	
h _{FE} ratio *1	h _{FE} (Small/Large)	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$	0.50	0.99		_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$		-0.2	-0.5	V
Transition frequency	f_T	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2		pF

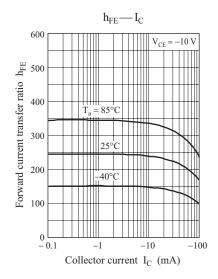
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

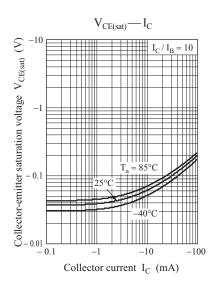
2. *1: Ratio between 2 elements

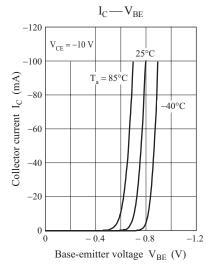
DMA50101 Panasonic

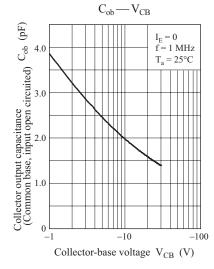


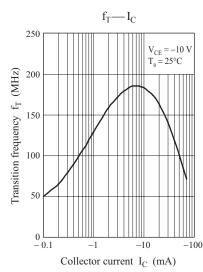








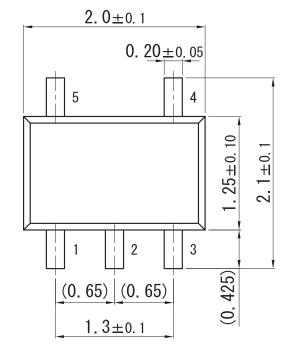


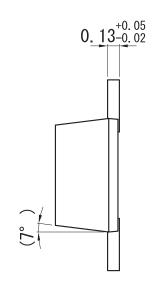


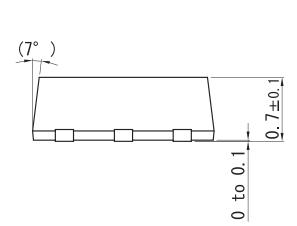
Ver. DED 2

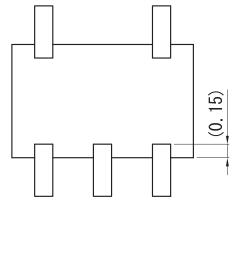
SMini5-F3-B

Unit: mm

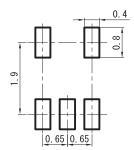








■ Land Pattern (Reference) (Unit: mm)



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